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## SK 3312.230 Liquid Cooling Package

POWER DISTRIBUTION >> CLIMATE CONTROL

State: 2025-07-06 (Source: rittal.com/ca-en)



IT INFRASTRUCTURE SOFTWARE & SERVICES

FRIEDHELM LOH GROUP

ENCLOSURES

# SK 3312.230 - Liquid Cooling Package LCP Rack CW, LCP Rack CWG

Cooling via high-performance compact impellers. The LCP draws in air from the side at the rear of the server enclosure and blows the cooled air back into the front part of the server enclosure from the side.

#### Features

Model No.	SK 3312.230
Benefits	Maximum energy efficiency due to EC fan technology and IT-based control
	Minimal pressure loss at the air end, which in turn minimizes the
	power consumption of the fans
	Control of the server inlet temperature
	Redundant temperature sensor integrated at the air end
	Optimum adaptability due to dynamic, continuous control of the cold water volume flow
	By using high water inlet temperatures, the proportion of indirect
	free cooling is increased, which in turn reduces operating costs
	Targeted cooling output thanks to modular fan units
	Fan modules configurable as n+1 redundancy.
	Standard 3-phase connection for electrical redundancy
	The separation of cooling and enclosure prevents water from entering the server enclosure
	A maximum floor area of 0.36 m <sup>2</sup> for all cooling services
	Improved heat recovery due to high water return temperatures when
	using the LCP CW glycol variants, for example in conjunction with a
	heat pump
	Optimum access for maintenance and service from the front and the rear
	Tool-free fan module replacement
Function principle	The LCP draws in the air at the sides at the rear of the server enclosures, cools it using high-performance compact impellers, and blows the cooled air back into the front part of the server enclosure at the sides
Material	Carbon steel, spray finished

#### Features

Color	RAL 7035
Options	Fully integrated fire detection and extinguisher system Automatic server enclosure door opening Direct connection of additional CMC III sensors is also possible Racks 2200 mm high
Version	Rack cooling
Monitoring	Monitoring of all system-relevant parameters such as server air intake temperature, server waste air temperature, water inlet/return temperature, water flow, cooling output, fan speed, leakage. Direct connection of the unit via SNMP over Ethernet Integration into RiZone
Total cooling output/number of fan modules	10 kW/1 20 kW/2 30 kW/3
Air throughput (unimpeded air flow)	At 50 Hz: 4,800 m³/h
Number of fan modules in supplied state	1
Dimensions	Width: 300 mm Height: 2,000 mm Depth: 1,200 mm
Suitable for enclosure type	TSIT
Installation in bayed enclosure suite	Flush
Rated operating voltage	230 V, 1~, 50 Hz/60 Hz 400 V, 3~, 50 Hz/60 Hz
Max. cooling output	30 kW
Type of connection (electrical)	Connector
Duty cycle	100 %
EC fan	Yes
Fans may be exchanged with the system operational	Yes

#### Features

Temperature control	Infinitely variable fan control 2-way control ball valve
Water connections	DN 40 (G 1½" external thread)
Permissible operating pressure (p. max.)	10 bar
Water inlet temperature	15 °C
Protection category IP to EN 60 529	IP 20
Options	Fully integrated fire detection and extinguisher system Automatic server enclosure door opening Direct connection of additional CMC III sensors is also possible Racks 2200 mm high
Packaging unit	1 pc(s).
Net weight	195
Gross weight	210
Customs tariff number	84186900
EAN	4028177811669
ETIM 9	EC002515
ETIM 8	EC002515
ECLASS 8.0	27180712

### Approvals

Certificates

EAC